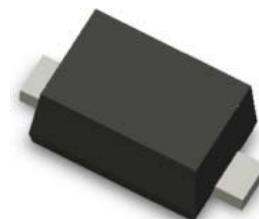
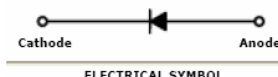


RB751S40

Schottky Barrier Diodes

- Low Forward Voltage Drop
- Flat Lead, Surface Mount Device at 0.60mm Height
- Extremely Small Outline Plastic Package SOD523F
- Moisture Level Sensitivity 1
- Pb-free Version and RoHS Compliant
- Matte Tin (Sn) Lead Finish
- Green Mold Compound



SOD-523F
Band Indicates Cathode*
Marking: 4B

Absolute Maximum Ratings* $T_a=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{RRM}	Maximum Repetitive Reverse Voltage	40	V
$I_{F(AV)}$	Average Rectified Forward Current	30	mA
I_{FSM}	Non-Repetitive Peak Forward Current	500	mA
T_J	Operating Junction Temperature Range	-55 to +125	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-55 to +125	$^{\circ}\text{C}$

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

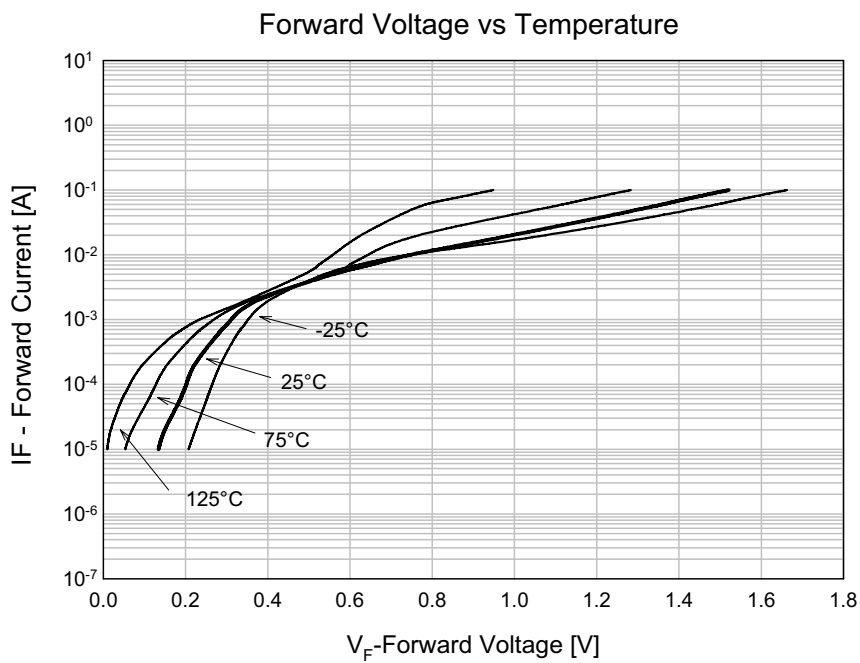
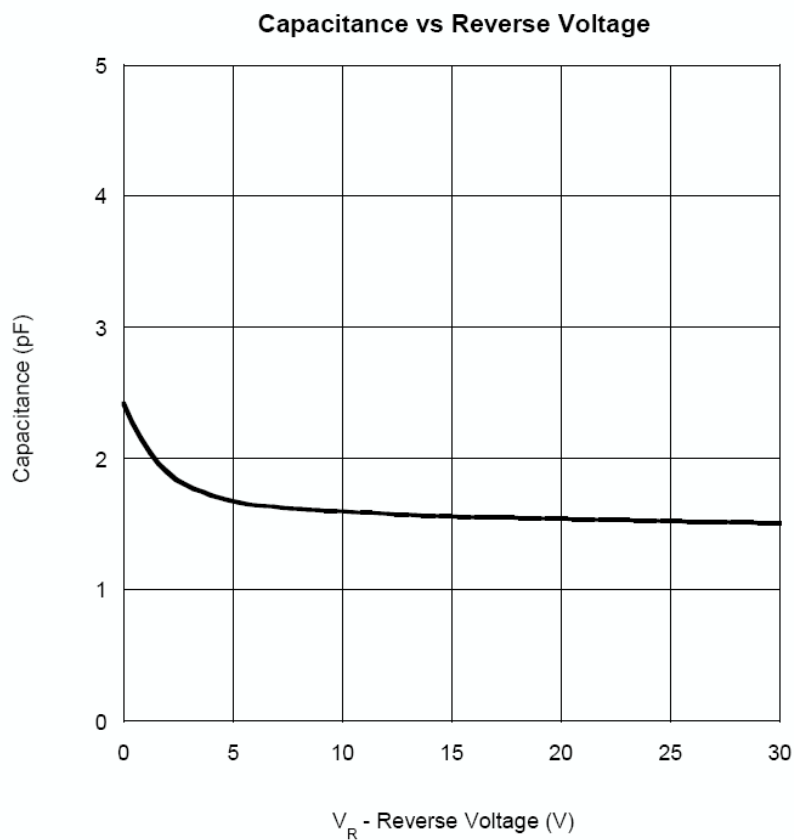
Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	500	$^{\circ}\text{C/W}$
P_D	Total Device Dissipation($T_C=25^{\circ}\text{C}$)	200	mW

*Device mounted on FR-4 PCB minimum land pad.

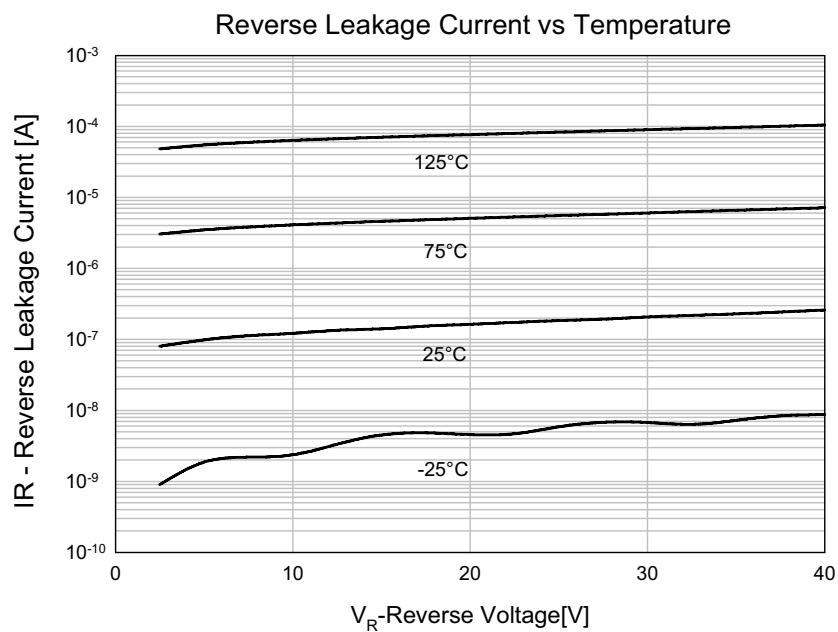
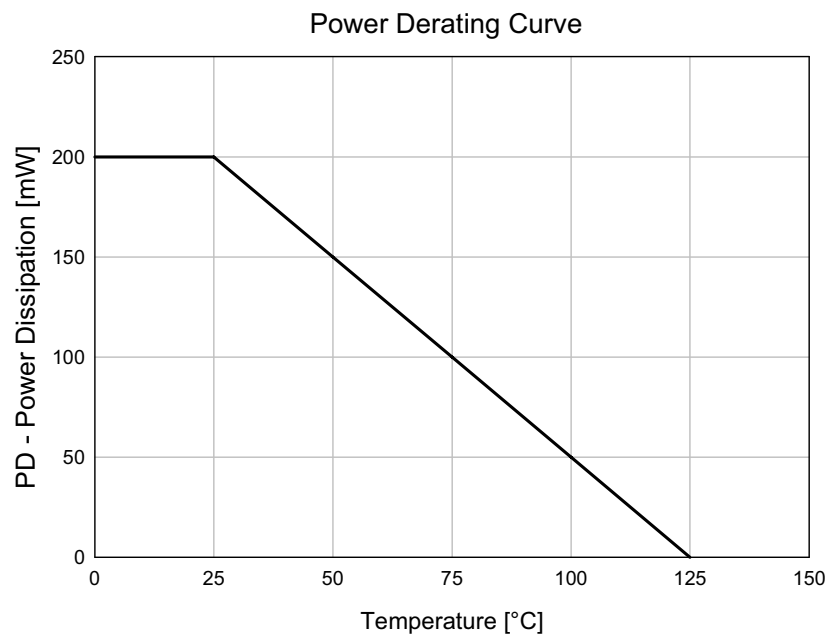
Electrical Characteristics* $T_a=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_R	Breakdown Voltage	$I_R = 500 \mu\text{A}$	30			V
I_R	Reverse Current	$V_R = 10 \text{ V}$			0.5	μA
V_F	Forward Voltage	$I_F = 1 \text{ mA}$			0.37	V

Typical Performance Characteristics

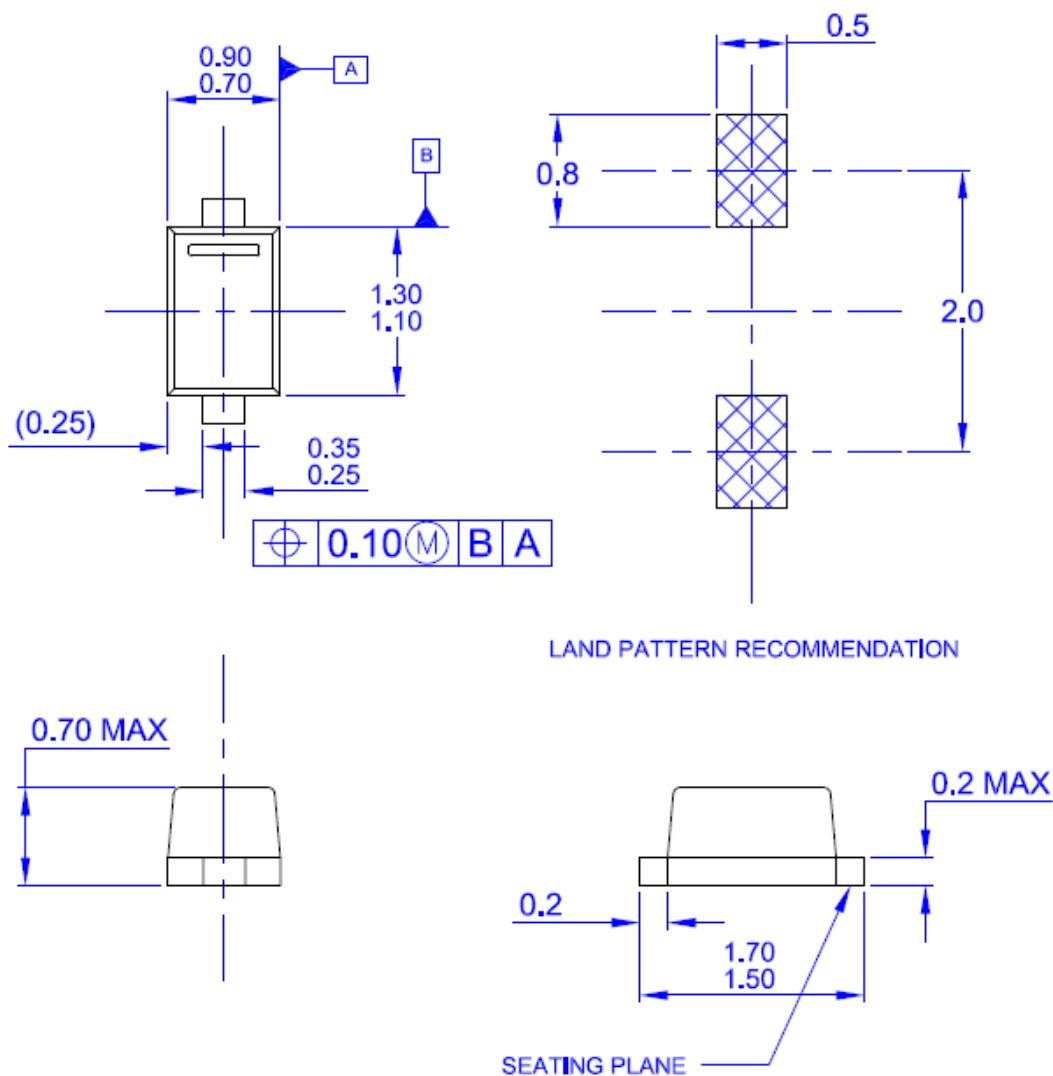


Typical Performance Characteristics



Package Dimension

SOD-523F



NOTES: UNLESS OTHERWISE SPECIFIED

- A) PACKAGE REFERENCE: THIS PACKAGE OUTLINE CONFORMS TO JEITA SC-79.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DRAWING CONFORMS TO ASME Y14.5M - 1994
- D) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- E) LANDPATTERN RECOMMENDATION IS BASED ON IPC7351A STANDARD SOD1609X65M.
- F) DRAWING NUMBER AND REVISION: MKT-SOD523F1rev1



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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
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